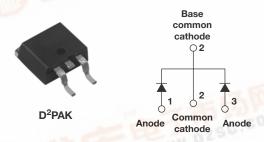


Vishay High Power Products

HALOGEN

FREE

HEXFRED® Ultrafast Soft Recovery Diode, 2 x 15 A



PRODUCT SUMMARY				
V_R	600 V			
V _F at 15 A at 25 °C	1.7 V			
I _{F(AV)}	2 x 15 A			
t _{rr} (typical)	19 ns			
T _J (maximum)	150 °C			
Q _{rr} (typical)	80 nC			
dl _{(rec)M} /dt (typical) at 125 °C	160 A/μs			
I _{RRM} (typical)	4.0 A			

FEATURES

- Ultrafast recovery
- Ultrasoft recovery
- Very low I_{RRM}
- Very low Q_{rr}
- Specified at operating conditions
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Halogen-free according to IEC 61249-2-21 definition
- Compliant to RoHS directive 2002/95/EC
- AEC-Q101 qualified

BENEFITS

- Reduced RFI and EMI
- Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

DESCRIPTION

VS-HFA30TA60CS is a state of the art center tap ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 V and 15 A per leg continuous current, the VS-HFA30TA60CS is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (IRRM) and does not exhibit any tendency to "snap-off" during the tb portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA30TA60CS is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V_R	47 7 Ct 1-1	600	V	
Maximum continuous forward current per leg	IF	T _C = 100 °C	15		
per device		IC = 100 C	30	Α	
Single pulse forward current	I _{FSM}		150	A	
Maximum repetitive forward current	I _{FRM}		60		
Maximum power dissipation	P _D	T _C = 25 °C	74	°C	
Maximum power dissipation		T _C = 100 °C	29		
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	W	



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ELECTRICAL SPECIFICATIONS PER LEG (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V_{BR}	Ι _R = 100 μΑ		600	-	-	
Maximum forward voltage V _{FN}		I _F = 15 A	See fig. 1	-	1.3	1.7	V
	V_{FM}	I _F = 30 A		-	1.5	2.0	
		I _F = 15 A, T _J = 125 °C		-	1.2	1.6	
Maximum reverse		V _R = V _R rated	See fig. 2	-	1.0	10	
leakage current	I _{RM}	$T_J = 125$ °C, $V_R = 0.8 \times V_R$ rated	See lig. 2	-	400	1000	μA
Junction capacitance	C _T	V _R = 200 V	See fig. 3	-	25	50	pF
Series inductance	L _S	Measured lead to lead 5 mm from package body - 8.0		-	nH		

DYNAMIC RECOVERY CHARACTERISTICS PER LEG (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
	t _{rr}	$I_F = 1.0 \text{ A}, dI_F/dt = 200$	$_{F}$ = 1.0 A, dl _F /dt = 200 A/µs, V_{R} = 30 V		19	-	
Reverse recovery time See fig. 5, 10	t _{rr1}	T _J = 25 °C	I _F = 15 A dI _F /dt = 200 A/μs V _R = 200 V	-	42	60	ns
000 lig. 0, 10	t _{rr2}	T _J = 125 °C		-	70	90	
Peak recovery current See fig. 6	I _{RRM1}	T _J = 25 °C		-	4.0	6.0	Α
	I _{RRM2}	T _J = 125 °C		-	6.5	10	
Reverse recovery charge	Q _{rr1}	T _J = 25 °C		-	80	180	nC
See fig. 7	Q _{rr2}	T _J = 125 °C		-	220	450	110
Peak rate of fall of recovery current during t_b $See fig. 8 \qquad \qquad \frac{dI_{(rec)M}/dt1}{dI_{(rec)M}/dt2} T_J = 25 ^{\circ}C$	T _J = 25 °C		-	188	-	A/µs	
	dI _{(rec)M} /dt2	T _J = 125 °C		-	160	-	-ν μο

THERMAL - MECHANICAL SPECIFICATIONS PER LEG						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Lead temperature	T _{lead}	0.063" from case (1.6 mm) for 10 s	-	-	300	°C
Junction to case, single leg conducting	В		-	-	1.7	
Junction to case, both legs conducting	- R _{thJC}		-	-	0.85	K/W
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	80	
Woight			-	2.0	-	g
Weight			-	0.07	-	oz.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)
Marking device		Case style D ² PAK		HFA30	TA60CS	•



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Ultrafast Soft Recovery Diode, 2 x 15 A

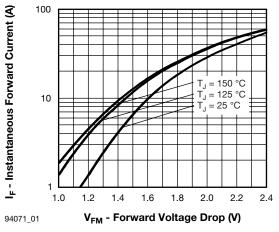


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current (Per Leg)

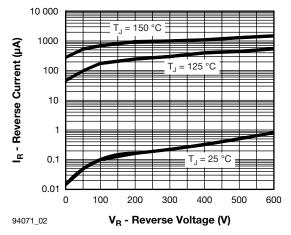


Fig. 2 - Typical Reverse Current vs. Reverse Voltage (Per Leg)

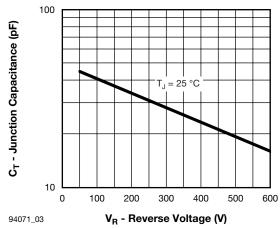


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

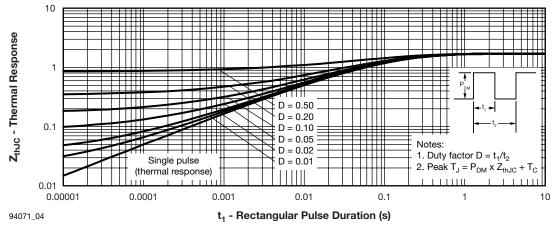


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

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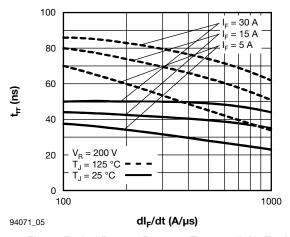


Fig. 5 - Typical Reverse Recovery Time vs. dl_F/dt (Per Leg)

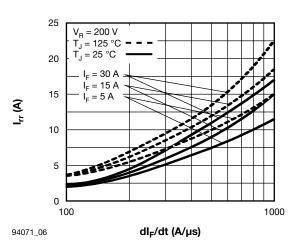


Fig. 6 - Typical Recovery Current vs. dI_F/dt (Per Leg)

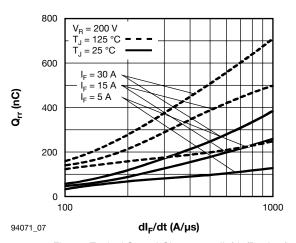


Fig. 7 - Typical Stored Charge vs. dI_F/dt (Per Leg)

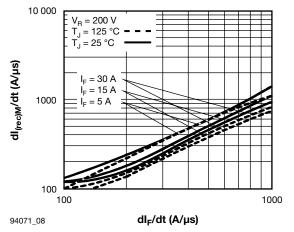


Fig. 8 - Typical $dI_{(rec)M}/dt$ vs. dI_F/dt (Per Leg)

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Ultrafast Soft Recovery Diode, 2 x 15 A

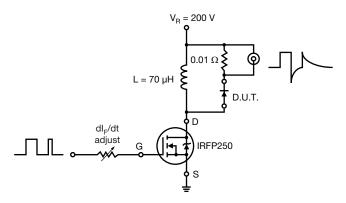
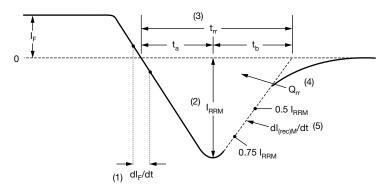


Fig. 9 - Reverse Recovery Parameter Test Circuit



- (1) dl_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.
- (4) $\rm Q_{rr}$ area under curve defined by $\rm t_{rr}$ and $\rm I_{RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

Fig. 10 - Reverse Recovery Waveform and Definitions

VS-HFA30TA60CSPbF

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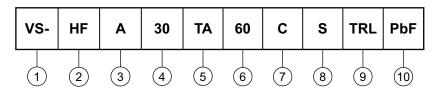
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ORDERING INFORMATION TABLE

Device code



1 - HPP product suffix

- HEXFRED® family

Process designator: A = Electron irradiated

4 - Current rating (30 = 30 A)

- Package outline (TA = TO-220, 3 leads)

6 - Voltage rating (60 = 600 V)

7 - Circuit configuration (C = Common cathode)

9 - • None = Tube (50 pieces)

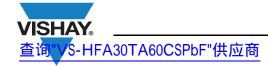
• TRL = Tape and reel (left oriented)

• TRR = Tape and reel (right oriented)

- PbF = Lead (Pb)-free

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95046			
Part marking information	www.vishay.com/doc?95054			
Packaging information	www.vishay.com/doc?95032			

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